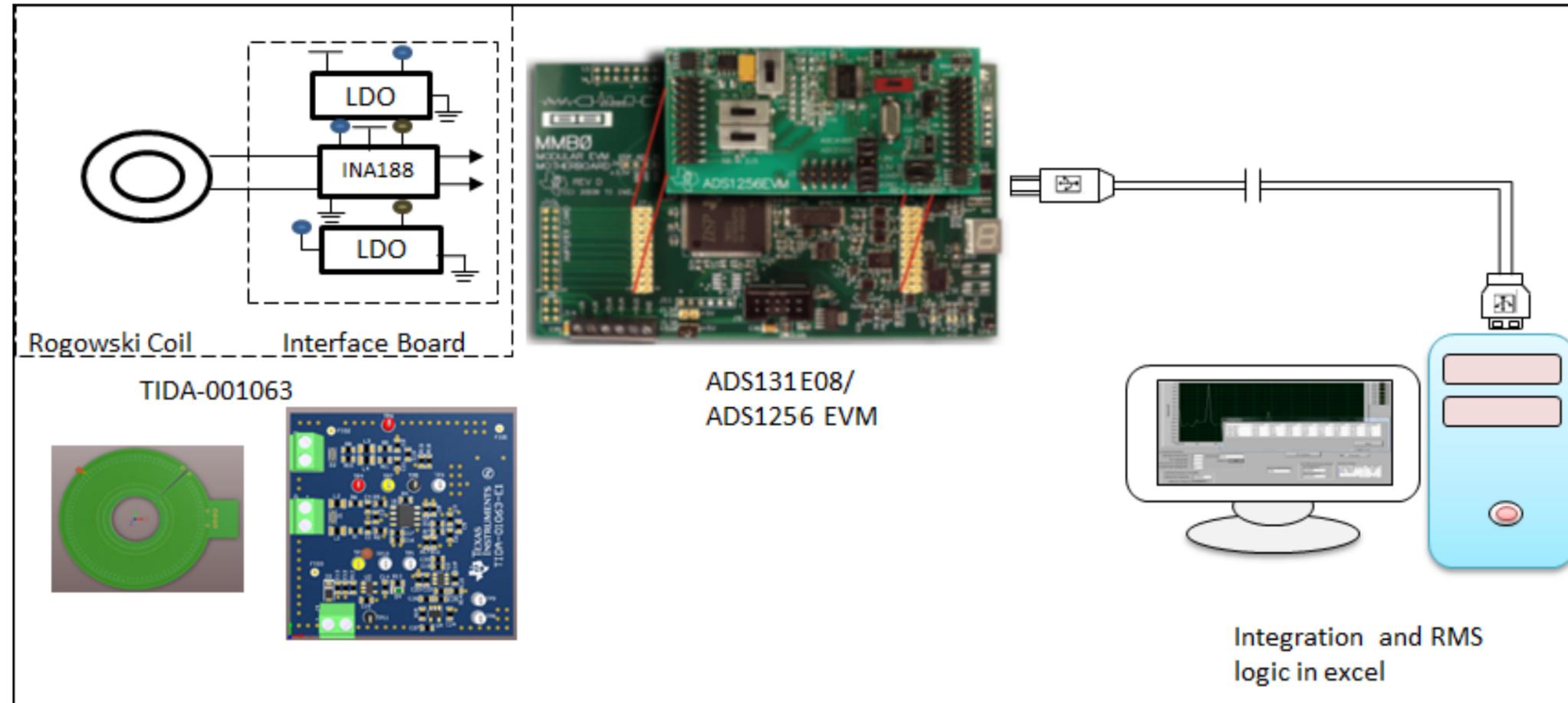


Revision History

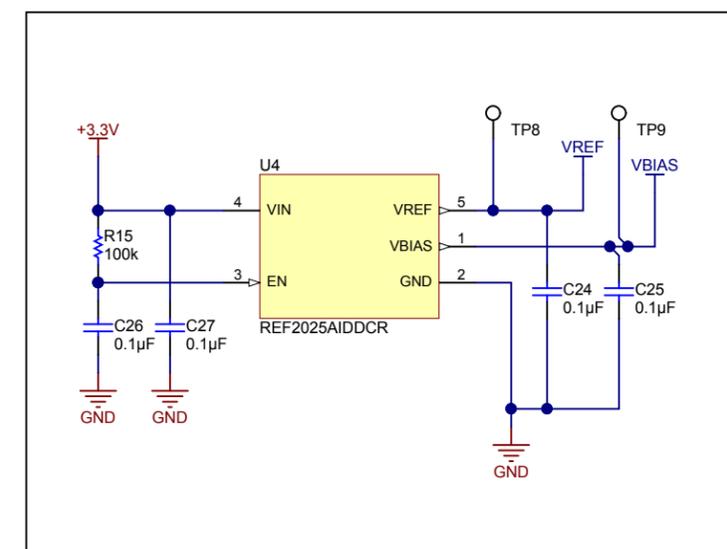
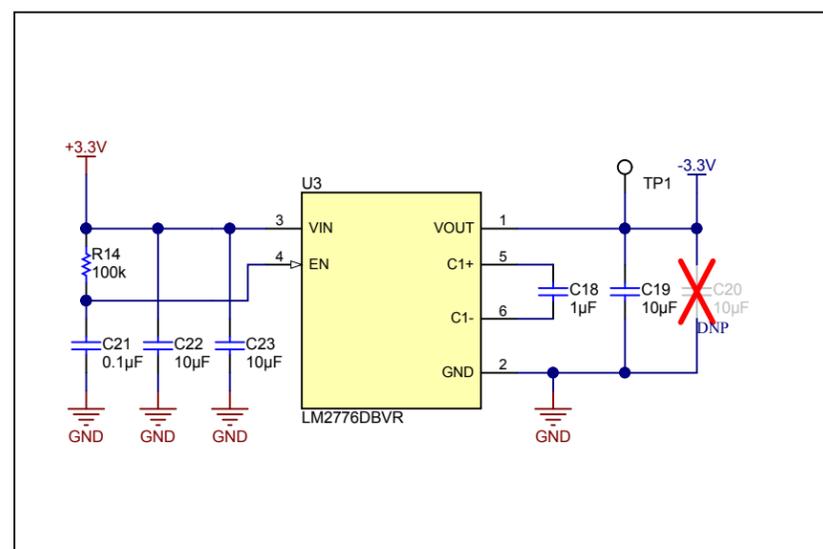
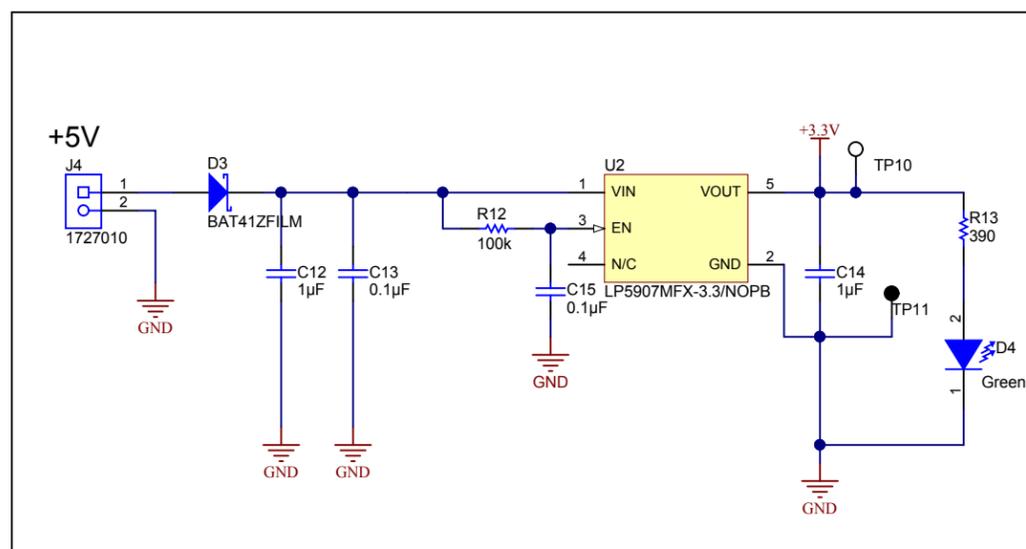
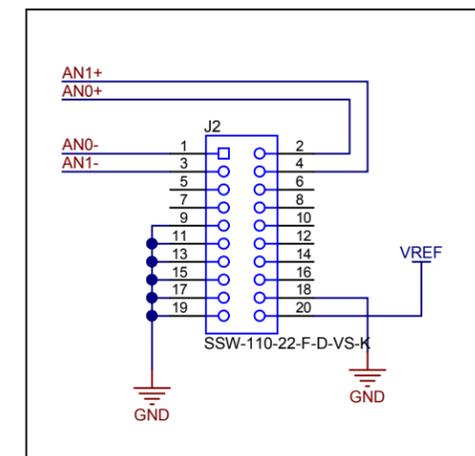
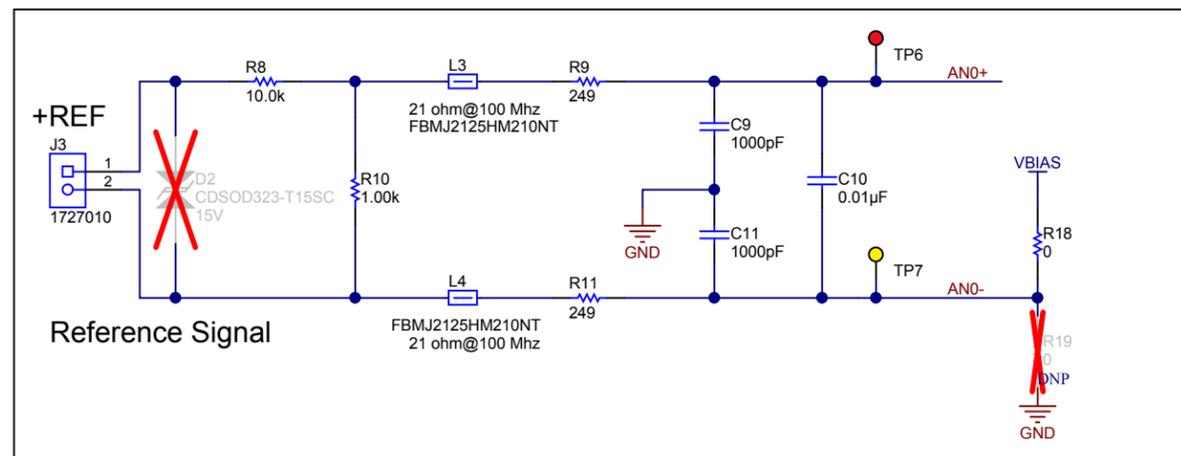
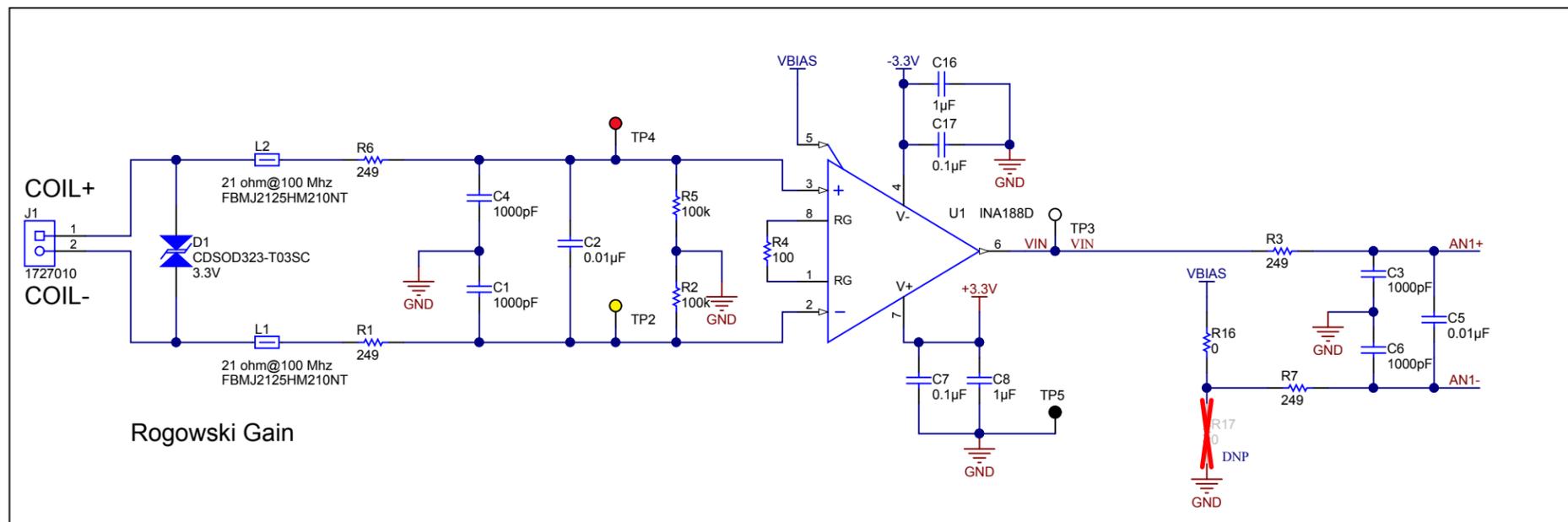
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: TIDA-01063	Project Title: Current Sensing using PCB Rogowski Coil	
Number: TIDA-01063	Rev: E1	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Srinivasan Iyer	File: TIDA-01063-CoverSheet.SchDoc	Size: B
Engineer: Srinivasan Iyer	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	





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TID #: TIDA-01063	Project Title: Current Sensing using PCB Rogowski Coil	
Number: TIDA-01063	Rev: E1	Sheet Title: PCB Rogowski Coil Amplifier
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Srinivasan Iyer	File: TIDA-01063-BlankSheet.SchDoc	Size: B
Engineer: Srinivasan Iyer	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

A

A



PCB Number: TIDA-01063  
PCB Rev: E1

PCB  
LOGO  
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PCB  
LOGO  
Pb-Free Symbol

B

B

ZZ1  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

C

C

D

D

Orderable: N/A	Designed for: Public Release	Mod. Date: 5/28/2016	
TID #: TIDA-01063	Project Title: Current Sensing using PCB Rogowski Coil		
Number: TIDA-01063	Rev: E1	Sheet Title: PCB Hardware	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: Srinivasan Iyer	File: TIDA-01063_Hardware.SchDoc	Size: B	http://www.ti.com
Engineer: Srinivasan Iyer	Contact: http://www.ti.com/support		© Texas Instruments 2016

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